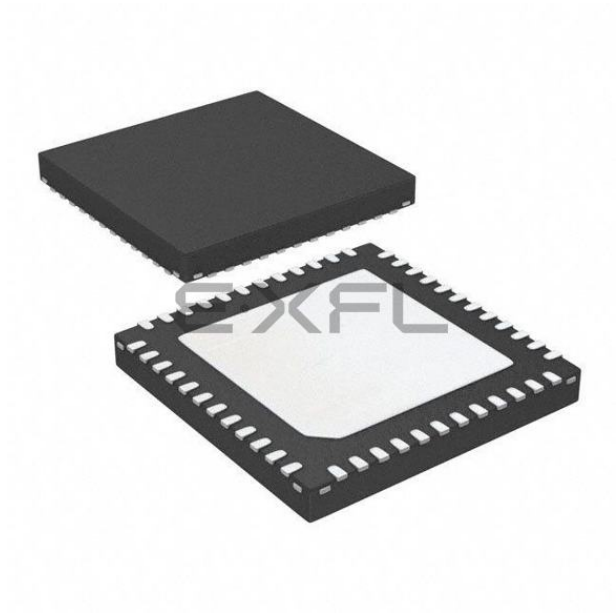
Renesas Electronics America Inc - R5F51105ADNE#U0 Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	32MHz
Connectivity	I²C, SCI, SPI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	34
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 10x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-WFQFN Exposed Pad
Supplier Device Package	48-HWQFN (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f51105adne-u0

Table 1.2 Comparison of Functions for Different Packages

Module/Functions		RX110 Group			
		64 Pins	48 Pins	40 Pins	36 Pins
Interrupts	External interrupts	NMI, IRQ0 to IRQ7			
DMA	Data transfer controller	Supported			
Timers	Multi-function timer pulse unit 2	4 channels (MTU0 to MTU2, MTU5)			
	Compare match timer	2 channels × 1 unit			
	Realtime clock	Supported		Not supported	
	Independent watchdog timer	Supported			
Communication functions	Serial communications interfaces [simple I2C, simple SPI]	2 channels (SCI1, SCI5)			
	Serial communications interface [simple I2C, simple SPI]	1 channel (SCI12)			
	I2C bus interface	1 channel			
	Serial peripheral interface	1 channel	1 channel (SSLA1 and SSLA3 are not supported)		1 channel (SSLA1 to SSLA3 are not supported)
12-bit A/D converter (including high-precision channels)		14 channels (6 channels)	10 channels (4 channels)	8 channels (3 channels)	7 channels (2 channels)
Temperature sensor		Supported			
CRC calculator		Supported			
Packages		64-pin LFQFP 64-pin LQFP 64-pin WFLGA	48-pin LFQFP 48-pin HWQFN	40-pin HWQFN	36-pin WFLGA

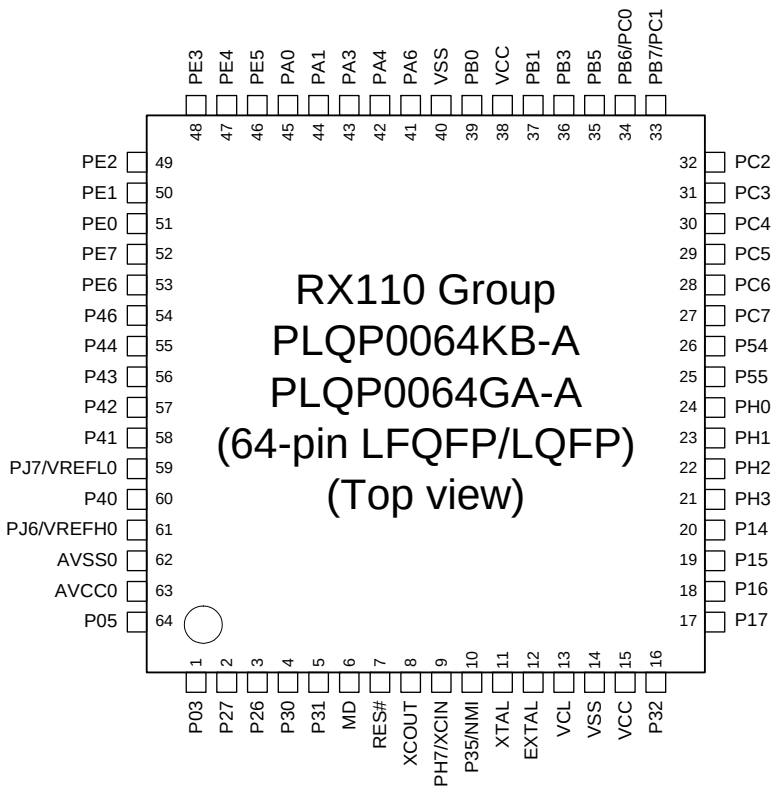
Table 1.3 List of Products (2/2)

Group	Part No.	Orderable Part No.	Package	ROM Capacity	RAM Capacity	Maximum Operating Frequency	Operating Temperature
RX110	R5F51105ADFM	R5F51105ADFM#30	PLQP0064KB-A	128 Kbytes	16 Kbytes	32MHz	–40 to +85°C
	R5F51105ADFK	R5F51105ADFK#30	PLQP0064GA-A				
	R5F51105ADLF	R5F51105ADLF#U0	PWLG0064KA-A				
	R5F51105ADFL	R5F51105ADFL#30	PLQP0048KB-A				
	R5F51105ADNE	R5F51105ADNE#U0	PWQN0048KB-A				
	R5F51104ADFM	R5F51104ADFM#30	PLQP0064KB-A	96 Kbytes			
	R5F51104ADFK	R5F51104ADFK#30	PLQP0064GA-A				
	R5F51104ADLF	R5F51104ADLF#U0	PWLG0064KA-A				
	R5F51104ADFL	R5F51104ADFL#30	PLQP0048KB-A				
	R5F51104ADNE	R5F51104ADNE#U0	PWQN0048KB-A				
	R5F51103ADFM	R5F51103ADFM#30	PLQP0064KB-A	64 Kbytes	10 Kbytes		
	R5F51103ADFK	R5F51103ADFK#30	PLQP0064GA-A				
	R5F51103ADLF	R5F51103ADLF#U0	PWLG0064KA-A				
	R5F51103ADFL	R5F51103ADFL#30	PLQP0048KB-A				
	R5F51103ADNE	R5F51103ADNE#U0	PWQN0048KB-A				
	R5F51103ADLM	R5F51103ADLM#U0	PWLG0036KA-A				
	R5F51103ADNF	R5F51103ADNF#U0	PWQN0040KC-A				
	R5F51101ADFM	R5F51101ADFM#30	PLQP0064KB-A	32 Kbytes			
	R5F51101ADFK	R5F51101ADFK#30	PLQP0064GA-A				
	R5F51101ADLF	R5F51101ADLF#U0	PWLG0064KA-A				
	R5F51101ADFL	R5F51101ADFL#30	PLQP0048KB-A				
	R5F51101ADNE	R5F51101ADNE#U0	PWQN0048KB-A				
	R5F51101ADLM	R5F51101ADLM#U0	PWLG0036KA-A				
	R5F51101ADNF	R5F51101ADNF#U0	PWQN0040KC-A				
	R5F5110JADFM	R5F5110JADFM#30	PLQP0064KB-A	16 Kbytes	8 Kbytes		
	R5F5110JADFK	R5F5110JADFK#30	PLQP0064GA-A				
	R5F5110JADLF	R5F5110JADLF#U0	PWLG0064KA-A				
	R5F5110JADFL	R5F5110JADFL#30	PLQP0048KB-A				
	R5F5110JADNE	R5F5110JADNE#U0	PWQN0048KB-A				
	R5F5110JADLM	R5F5110JADLM#U0	PWLG0036KA-A				
	R5F5110JADNF	R5F5110JADNF#U0	PWQN0040KC-A				
	R5F5110HADLM	R5F5110HADLM#U0	PWLG0036KA-A	8 Kbytes			
	R5F5110HADNF	R5F5110HADNF#U0	PWQN0040KC-A				

Note: Orderable part numbers are current as of when this manual was published. Please make sure to refer to the relevant product page on the Renesas website for the latest part numbers.

1.5 Pin Assignments

Figure 1.3 to Figure 1.7 show the pin assignments. Table 1.5 to Table 1.9 show the lists of pins and pin functions.



Note: This figure indicates the power supply pins and I/O ports.
For the pin configuration, see the table “List of Pins and Pin Functions (64-Pin LFQFP/LQFP)”.

Figure 1.3 Pin Assignments of the 64-Pin LFQFP/LQFP

Table 1.9 List of Pins and Pin Functions (36-Pin WFLGA)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, RTC)	Communication (SCIe, SCIf, RSPI, RIIC)	Others
A1	AVSS0				
A2	AVCC0				
A3	VREFH0	PJ6*1			
A4		P42*1			AN002
A5		P41*1			AN001
A6		PE2		RXD12/RXDX12/SMISO12/SSCL12	IRQ7/AN010
B1	RES#				
B2		P27	MTIOC2B	SCK1/SCK12	IRQ3/CMPA2/ CACREF/ADTRG0#
B3	VREFL0	PJ7*1			
B4		PE0	MTIOC2A	SCK12	IRQ0/AN008
B5		PE1		TXD12/TXDX12/SIOX12/SMOSI12/ SSDA12	IRQ1/AN009
B6		PA3	MTIOC0D/MTCLKD/ MTIOC1B	RXD5/SMISO5/SSCL5/MISOA	IRQ6
C1	XTAL				
C2	MD				FINED
C3		PE3	MTIOC0A/MTIOC1B	CTS12#/RTS12#/SS12#/RSPCKA	IRQ3/AN011
C4		PE4	MTIOC1A	MOSIA	IRQ4/AN012
C5		PA4	MTIOC2B/MTIC5U/MTCLKA	TXD5/SMOSI5/SSDA5/SSLA0	IRQ5
C6	VSS				
D1	EXTAL				
D2		P35			NMI
D3		P14	MTIOC0A/MTCLKA	CTS1#/RTS1#/SS1#/SSLA0/TXD12/ TXDX12/SIOX12/SMOSI12/SSDA12	IRQ4
D4		PA6	MTIC5V/MTCLKB/MTIOC2A	CTS5#/RTS5#/SS5#/SDA0/MOSIA	IRQ3
D5		PB3	MTIOC0A		
D6		PB0	MTIOC0C/MTIC5W	SCL0/RSPCKA	IRQ2/ADTRG0#
E1	VCL				
E2		P17	MTIOC0C	SCK1/MISOA/SDA0/RXD12/RXDX12/ SMISO12/SSCL12	IRQ7
E3		P16		TXD1/SMOSI1/SSDA1/SCL0/MOSIA	IRQ6/ADTRG0#
E4		P15	MTIOC0B/MTCLKB	RXD1/SMISO1/SSCL1/RSPCKA	IRQ5/CLKOUT
E5		PC4	MTCLKC	SCK5/SSLA0	IRQ2/CLKOUT
E6	VCC				
F1	VSS				
F2	VCC				
F3		PH3	MTIOC1A		
F4		PH2			IRQ1
F5		PH1			IRQ0
F6		PH0	MTIOC1B		CACREF

Note 1. The power source of the I/O buffer for these pins is AVCC0.

Table 4.1 List of I/O Registers (Address Order) (5/13)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 73DEh	ICU	Interrupt Source Priority Register 222	IPR222	8	8	2 ICLK
0008 73EEh	ICU	Interrupt Source Priority Register 238	IPR238	8	8	2 ICLK
0008 73F2h	ICU	Interrupt Source Priority Register 242	IPR242	8	8	2 ICLK
0008 73F3h	ICU	Interrupt Source Priority Register 243	IPR243	8	8	2 ICLK
0008 73F4h	ICU	Interrupt Source Priority Register 244	IPR244	8	8	2 ICLK
0008 73F5h	ICU	Interrupt Source Priority Register 245	IPR245	8	8	2 ICLK
0008 73F6h	ICU	Interrupt Source Priority Register 246	IPR246	8	8	2 ICLK
0008 73F7h	ICU	Interrupt Source Priority Register 247	IPR247	8	8	2 ICLK
0008 73F8h	ICU	Interrupt Source Priority Register 248	IPR248	8	8	2 ICLK
0008 73F9h	ICU	Interrupt Source Priority Register 249	IPR249	8	8	2 ICLK
0008 7500h	ICU	IRQ Control Register 0	IRQCR0	8	8	2 ICLK
0008 7501h	ICU	IRQ Control Register 1	IRQCR1	8	8	2 ICLK
0008 7502h	ICU	IRQ Control Register 2	IRQCR2	8	8	2 ICLK
0008 7503h	ICU	IRQ Control Register 3	IRQCR3	8	8	2 ICLK
0008 7504h	ICU	IRQ Control Register 4	IRQCR4	8	8	2 ICLK
0008 7505h	ICU	IRQ Control Register 5	IRQCR5	8	8	2 ICLK
0008 7506h	ICU	IRQ Control Register 6	IRQCR6	8	8	2 ICLK
0008 7507h	ICU	IRQ Control Register 7	IRQCR7	8	8	2 ICLK
0008 7510h	ICU	IRQ Pin Digital Filter Enable Register 0	IRQFLTE0	8	8	2 ICLK
0008 7514h	ICU	IRQ Pin Digital Filter Setting Register 0	IRQFLTC0	16	16	2 ICLK
0008 7580h	ICU	Non-Maskable Interrupt Status Register	NMISR	8	8	2 ICLK
0008 7581h	ICU	Non-Maskable Interrupt Enable Register	NMIER	8	8	2 ICLK
0008 7582h	ICU	Non-Maskable Interrupt Status Clear Register	NMICLR	8	8	2 ICLK
0008 7583h	ICU	NMI Pin Interrupt Control Register	NMICR	8	8	2 ICLK
0008 7590h	ICU	NMI Pin Digital Filter Enable Register	NMIFLTE	8	8	2 ICLK
0008 7594h	ICU	NMI Pin Digital Filter Setting Register	NMIFLTC	8	8	2 ICLK
0008 8000h	CMT	Compare Match Timer Start Register 0	CMSTR0	16	16	2 or 3 PCLKB
0008 8002h	CMT0	Compare Match Timer Control Register	CMCR	16	16	2 or 3 PCLKB
0008 8004h	CMT0	Compare Match Timer Counter	CMCNT	16	16	2 or 3 PCLKB
0008 8006h	CMT0	Compare Match Timer Constant Register	CMCOR	16	16	2 or 3 PCLKB
0008 8008h	CMT1	Compare Match Timer Control Register	CMCR	16	16	2 or 3 PCLKB
0008 800Ah	CMT1	Compare Match Timer Counter	CMCNT	16	16	2 or 3 PCLKB
0008 800Ch	CMT1	Compare Match Timer Constant Register	CMCOR	16	16	2 or 3 PCLKB
0008 8030h	IWDT	IWDT Refresh Register	IWDTRR	8	8	2 or 3 PCLKB
0008 8032h	IWDT	IWDT Control Register	IWDTCR	16	16	2 or 3 PCLKB
0008 8034h	IWDT	IWDT Status Register	IWDTSR	16	16	2 or 3 PCLKB
0008 8036h	IWDT	IWDT Reset Control Register	IWDTRCR	8	8	2 or 3 PCLKB
0008 8038h	IWDT	IWDT Count Stop Control Register	IWDTCSTPR	8	8	2 or 3 PCLKB
0008 8280h	CRC	CRC Control Register	CRCCR	8	8	2 or 3 PCLKB
0008 8281h	CRC	CRC Data Input Register	CRCDIR	8	8	2 or 3 PCLKB
0008 8282h	CRC	CRC Data Output Register	CRCDOR	16	16	2 or 3 PCLKB
0008 8300h	RIIC0	I^2C Bus Control Register 1	ICCR1	8	8	2 or 3 PCLKB
0008 8301h	RIIC0	I^2C Bus Control Register 2	ICCR2	8	8	2 or 3 PCLKB
0008 8302h	RIIC0	I^2C Bus Mode Register 1	ICMR1	8	8	2 or 3 PCLKB
0008 8303h	RIIC0	I^2C Bus Mode Register 2	ICMR2	8	8	2 or 3 PCLKB
0008 8304h	RIIC0	I^2C Bus Mode Register 3	ICMR3	8	8	2 or 3 PCLKB
0008 8305h	RIIC0	I^2C Bus Function Enable Register	ICFER	8	8	2 or 3 PCLKB
0008 8306h	RIIC0	I^2C Bus Status Enable Register	ICSER	8	8	2 or 3 PCLKB
0008 8307h	RIIC0	I^2C Bus Interrupt Enable Register	ICIER	8	8	2 or 3 PCLKB
0008 8308h	RIIC0	I^2C Bus Status Register 1	ICSR1	8	8	2 or 3 PCLKB
0008 8309h	RIIC0	I^2C Bus Status Register 2	ICSR2	8	8	2 or 3 PCLKB
0008 830Ah	RIIC0	Slave Address Register L0	SARL0	8	8	2 or 3 PCLKB

Table 4.1 List of I/O Registers (Address Order) (10/13)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 C024h	PORT4	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C025h	PORT5	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C02Ah	PORTA	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C02Bh	PORTB	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C02Ch	PORTC	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C02Eh	PORTE	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C031h	PORTH	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C032h	PORTJ	Port Output Data Register	PODR	8	8	2 or 3 PCLKB
0008 C040h	PORT0	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C041h	PORT1	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C042h	PORT2	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C043h	PORT3	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C044h	PORT4	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C045h	PORT5	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C04Ah	PORTA	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C04Bh	PORTB	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C04Ch	PORTC	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C04Eh	PORTE	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C051h	PORTH	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C052h	PORTJ	Port Input Data Register	PIDR	8	8	3 or 4 PCLKB cycles when reading, 2 or 3 PCLKB cycles when writing
0008 C060h	PORT0	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C061h	PORT1	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C062h	PORT2	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C063h	PORT3	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C064h	PORT4	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C065h	PORT5	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C06Ah	PORTA	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C06Bh	PORTB	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C06Ch	PORTC	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C06Eh	PORTE	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C071h	PORTH	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C072h	PORTJ	Port Mode Register	PMR	8	8	2 or 3 PCLKB
0008 C083h	PORT1	Open Drain Control Register 1	ODR1	8	8, 16	2 or 3 PCLKB
0008 C085h	PORT2	Open Drain Control Register 1	ODR1	8	8, 16	2 or 3 PCLKB
0008 C086h	PORT3	Open Drain Control Register 0	ODR0	8	8, 16	2 or 3 PCLKB
0008 C094h	PORTA	Open Drain Control Register 0	ODR0	8	8, 16	2 or 3 PCLKB
0008 C095h	PORTA	Open Drain Control Register 1	ODR1	8	8, 16	2 or 3 PCLKB
0008 C096h	PORTB	Open Drain Control Register 0	ODR0	8	8, 16	2 or 3 PCLKB
0008 C097h	PORTB	Open Drain Control Register 1	ODR1	8	8, 16	2 or 3 PCLKB
0008 C098h	PORTC	Open Drain Control Register 0	ODR0	8	8, 16	2 or 3 PCLKB
0008 C099h	PORTC	Open Drain Control Register 1	ODR1	8	8, 16	2 or 3 PCLKB
0008 C09Ch	PORTE	Open Drain Control Register 0	ODR0	8	8, 16	2 or 3 PCLKB
0008 C09Dh	PORTE	Open Drain Control Register 1	ODR1	8	8, 16	2 or 3 PCLKB
0008 C0C0h	PORT0	Pull-Up Control Register	PCR	8	8	2 or 3 PCLKB
0008 C0C1h	PORT1	Pull-Up Control Register	PCR	8	8	2 or 3 PCLKB
0008 C0C2h	PORT2	Pull-Up Control Register	PCR	8	8	2 or 3 PCLKB

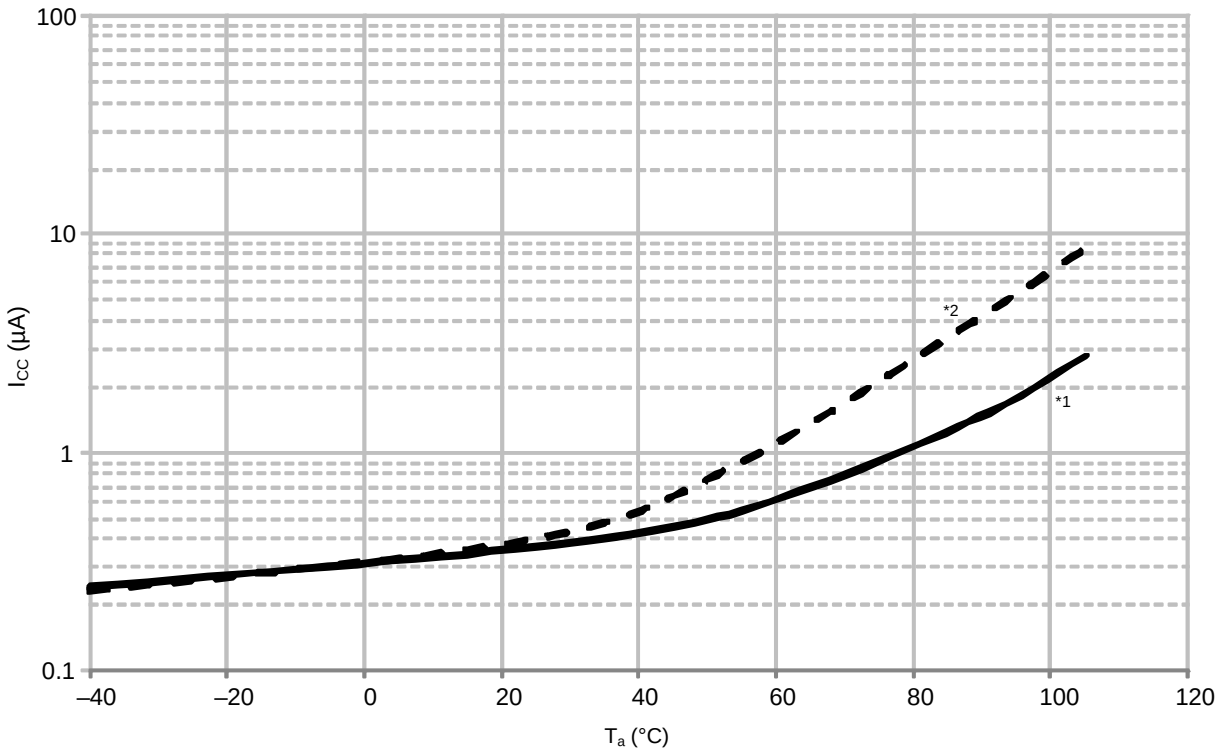
Table 4.1 List of I/O Registers (Address Order) (11/13)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 C0C3h	PORT3	Pull-Up Control Register	PCR	8	8	2 or 3 PCLKB
0008 C0C5h	PORT5	Pull-Up Control Register	PCR	8	8	2 or 3 PCLKB
0008 C0CAh	PORTA	Pull-Up Control Register	PCR	8	8	2 or 3 PCLKB
0008 C0CBh	PORTB	Pull-Up Control Register	PCR	8	8	2 or 3 PCLKB
0008 C0CCh	PORTC	Pull-Up Control Register	PCR	8	8	2 or 3 PCLKB
0008 C0CEh	PORTE	Pull-Up Control Register	PCR	8	8	2 or 3 PCLKB
0008 C0D1h	PORTH	Pull-Up Control Register	PCR	8	8	2 or 3 PCLKB
0008 C11Fh	MPC	Write-Protect Register	PWPR	8	8	2 or 3 PCLKB
0008 C120h	PORT	Port Switching Register B	PSRB	8	8	2 or 3 PCLKB
0008 C121h	PORT	Port Switching Register A	PSRA	8	8	2 or 3 PCLKB
0008 C14Ch	MPC	P14 Pin Function Control Register	P14PFS	8	8	2 or 3 PCLKB
0008 C14Dh	MPC	P15 Pin Function Control Register	P15PFS	8	8	2 or 3 PCLKB
0008 C14Eh	MPC	P16 Pin Function Control Register	P16PFS	8	8	2 or 3 PCLKB
0008 C14Fh	MPC	P17 Pin Function Control Register	P17PFS	8	8	2 or 3 PCLKB
0008 C156h	MPC	P26 Pin Function Control Register	P26PFS	8	8	2 or 3 PCLKB
0008 C157h	MPC	P27 Pin Function Control Register	P27PFS	8	8	2 or 3 PCLKB
0008 C158h	MPC	P30 Pin Function Control Register	P30PFS	8	8	2 or 3 PCLKB
0008 C159h	MPC	P31 Pin Function Control Register	P31PFS	8	8	2 or 3 PCLKB
0008 C15Ah	MPC	P32 Pin Function Control Register	P32PFS	8	8	2 or 3 PCLKB
0008 C160h	MPC	P40 Pin Function Control Register	P40PFS	8	8	2 or 3 PCLKB
0008 C161h	MPC	P41 Pin Function Control Register	P41PFS	8	8	2 or 3 PCLKB
0008 C162h	MPC	P42 Pin Function Control Register	P42PFS	8	8	2 or 3 PCLKB
0008 C163h	MPC	P43 Pin Function Control Register	P43PFS	8	8	2 or 3 PCLKB
0008 C164h	MPC	P44 Pin Function Control Register	P44PFS	8	8	2 or 3 PCLKB
0008 C166h	MPC	P46 Pin Function Control Register	P46PFS	8	8	2 or 3 PCLKB
0008 C190h	MPC	PA0 Pin Function Control Register	PA0PFS	8	8	2 or 3 PCLKB
0008 C191h	MPC	PA1 Pin Function Control Register	PA1PFS	8	8	2 or 3 PCLKB
0008 C193h	MPC	PA3 Pin Function Control Register	PA3PFS	8	8	2 or 3 PCLKB
0008 C194h	MPC	PA4 Pin Function Control Register	PA4PFS	8	8	2 or 3 PCLKB
0008 C196h	MPC	PA6 Pin Function Control Register	PA6PFS	8	8	2 or 3 PCLKB
0008 C198h	MPC	PB0 Pin Function Control Register	PB0PFS	8	8	2 or 3 PCLKB
0008 C199h	MPC	PB1 Pin Function Control Register	PB1PFS	8	8	2 or 3 PCLKB
0008 C19Bh	MPC	PB3 Pin Function Control Register	PB3PFS	8	8	2 or 3 PCLKB
0008 C19Dh	MPC	PB5 Pin Function Control Register	PB5PFS	8	8	2 or 3 PCLKB
0008 C19Eh	MPC	PB6 Pin Function Control Register	PB6PFS	8	8	2 or 3 PCLKB
0008 C19Fh	MPC	PB7 Pin Function Control Register	PB7PFS	8	8	2 or 3 PCLKB
0008 C1A2h	MPC	PC2 Pin Function Control Register	PC2PFS	8	8	2 or 3 PCLKB
0008 C1A3h	MPC	PC3 Pin Function Control Register	PC3PFS	8	8	2 or 3 PCLKB
0008 C1A4h	MPC	PC4 Pin Function Control Register	PC4PFS	8	8	2 or 3 PCLKB
0008 C1A5h	MPC	PC5 Pin Function Control Register	PC5PFS	8	8	2 or 3 PCLKB
0008 C1A6h	MPC	PC6 Pin Function Control Register	PC6PFS	8	8	2 or 3 PCLKB
0008 C1A7h	MPC	PC7 Pin Function Control Register	PC7PFS	8	8	2 or 3 PCLKB
0008 C1B0h	MPC	PE0 Pin Function Control Register	PE0PFS	8	8	2 or 3 PCLKB
0008 C1B1h	MPC	PE1 Pin Function Control Register	PE1PFS	8	8	2 or 3 PCLKB
0008 C1B2h	MPC	PE2 Pin Function Control Register	PE2PFS	8	8	2 or 3 PCLKB
0008 C1B3h	MPC	PE3 Pin Function Control Register	PE3PFS	8	8	2 or 3 PCLKB
0008 C1B4h	MPC	PE4 Pin Function Control Register	PE4PFS	8	8	2 or 3 PCLKB
0008 C1B5h	MPC	PE5 Pin Function Control Register	PE5PFS	8	8	2 or 3 PCLKB
0008 C1B6h	MPC	PE6 Pin Function Control Register	PE6PFS	8	8	2 or 3 PCLKB
0008 C1B7h	MPC	PE7 Pin Function Control Register	PE7PFS	8	8	2 or 3 PCLKB
0008 C1C8h	MPC	PH0 Pin Function Control Register	PH0PFS	8	8	2 or 3 PCLKB
0008 C1C9h	MPC	PH1 Pin Function Control Register	PH1PFS	8	8	2 or 3 PCLKB

Table 5.7 DC Characteristics (5) (1/2)

Conditions: 1.8 V ≤ VCC ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = 0 V, T_a = –40 to +105°C

Item					Symbol	Typ *4	Max	Unit	Test Conditions
Supply current*1	High-speed operating mode	Normal operating mode	No peripheral operation*2	ICLK = 32 MHz	I_{CC}	3.2	—	mA	
				ICLK = 16 MHz		2.1	—		
				ICLK = 8 MHz		1.5	—		
			All peripheral operation: Normal*3	ICLK = 32 MHz		9.6	—		
				ICLK = 16 MHz		5.6	—		
				ICLK = 8 MHz		3.5	—		
			All peripheral operation: Max.*3	ICLK = 32 MHz		—	21.6		
		Sleep mode	No peripheral operation*2	ICLK = 32 MHz		1.5	—		
				ICLK = 16 MHz		1.2	—		
				ICLK = 8 MHz		1.0	—		
			All peripheral operation: Normal*3	ICLK = 32 MHz		5.1	—		
				ICLK = 16 MHz		3.1	—		
				ICLK = 8 MHz		2.0	—		
		Deep sleep mode	No peripheral operation*2	ICLK = 32 MHz		1.0	—		
				ICLK = 16 MHz		0.80	—		
				ICLK = 8 MHz		0.70	—		
			All peripheral operation: Normal*3	ICLK = 32 MHz		3.4	—		
				ICLK = 16 MHz		2.2	—		
				ICLK = 8 MHz		1.5	—		
	Middle-speed operating modes	Normal operating mode	No peripheral operation*5	ICLK = 12 MHz	I_{CC}	1.7	—	mA	
				ICLK = 8 MHz		1.3	—		
				ICLK = 1 MHz		0.72	—		
			All peripheral operation: Normal*6	ICLK = 12 MHz		4.2	—		
				ICLK = 8 MHz		3.3	—		
				ICLK = 1 MHz		1.2	—		
			All peripheral operation: Max.*6	ICLK = 12 MHz		—	10		
		Sleep mode	No peripheral operation*5	ICLK = 12 MHz		1.0	—		
				ICLK = 8 MHz		0.82	—		
				ICLK = 1 MHz		0.65	—		
			All peripheral operation: Normal*6	ICLK = 12 MHz		2.3	—		
				ICLK = 8 MHz		1.9	—		
				ICLK = 1 MHz		1.0	—		
		Deep sleep mode	No peripheral operation*5	ICLK = 12 MHz		0.8	—		
				ICLK = 8 MHz		0.66	—		
				ICLK = 1 MHz		0.58	—		
			All peripheral operation: Normal*6	ICLK = 12 MHz		1.6	—		
				ICLK = 8 MHz		1.5	—		
				ICLK = 1 MHz		0.87	—		



Note 1. Average value of the tested middle samples during product evaluation.
Note 2. Average value of the tested upper-limit samples during product evaluation.

Figure 5.5 Temperature Dependency in Software Standby Mode (Reference Data)

Table 5.9 DC Characteristics (7)

Conditions: 1.8 V ≤ VCC ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = 0 V

Item	Symbol	Typ.	Max.	Unit	Test Conditions
Permissible total consumption power*1	Pd	—	300	mW	D version (T_a = -40 to 85°C)
		—	105		G version (T_a = -40 to 105°C)*2

Note 1. Total power dissipated by the entire chip (including output currents).
Note 2. Please contact Renesas Electronics sales office for derating under T_a = +85°C to 105°C. Derating is the systematic reduction of load for the sake of improved reliability.

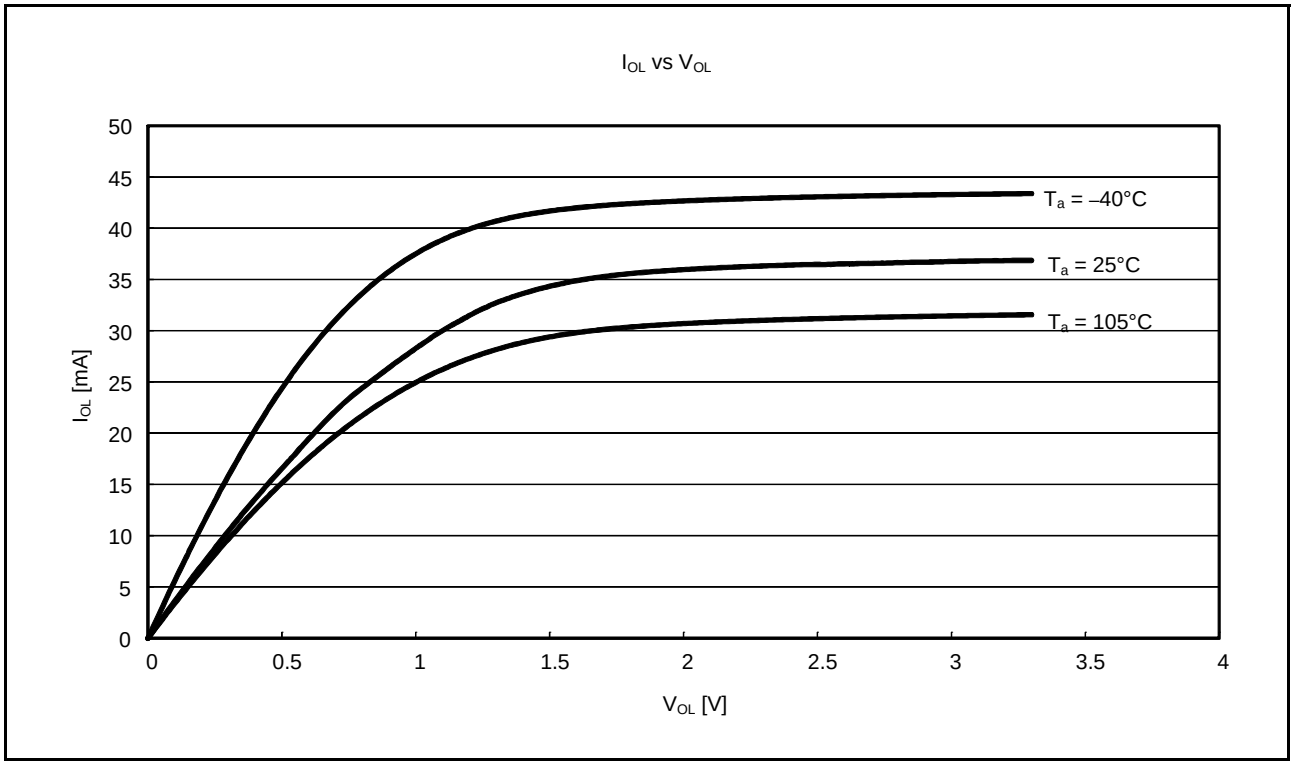


Figure 5.13 V_{OL} and I_{OL} Temperature Characteristics of RIIC Output Pin at VCC = 3.3 V (Reference Data)

5.3.2 Reset Timing

Table 5.23 Reset Timing

Conditions: 1.8 V ≤ VCC ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
RES# pulse width	At power-on	t_{RESWP}	3	—	—	ms	Figure 5.25
	Other than above	t_{RESW}	30	—	—	μs	Figure 5.26
Wait time after RES# cancellation (at power-on)	At normal startup*1	t_{RESWT}	—	8.5	—	ms	Figure 5.25
	During fast startup time*2	t_{RESWT}	—	560	—	μs	
Wait time after RES# cancellation (during powered-on state)		t_{RESWT}	—	114	—	μs	Figure 5.26
Independent watchdog timer reset period		t_{RESWIW}	—	1	—	IWDT clock cycle	Figure 5.27
Software reset period		t_{RESWSW}	—	1	—	ICLK cycle	
Wait time after independent watchdog timer reset cancellation*3		t_{RESW2}	—	300	—	μs	
Wait time after software reset cancellation		t_{RESW2}	—	168	—	μs	

Note 1. When OFS1.(STUPLVD1REN, FASTSTUP) = 11b.
Note 2. When OFS1.(STUPLVD1REN, FASTSTUP) ≠ 11b.
Note 3. When IWDTCR.CKS[3:0] = 0000b.

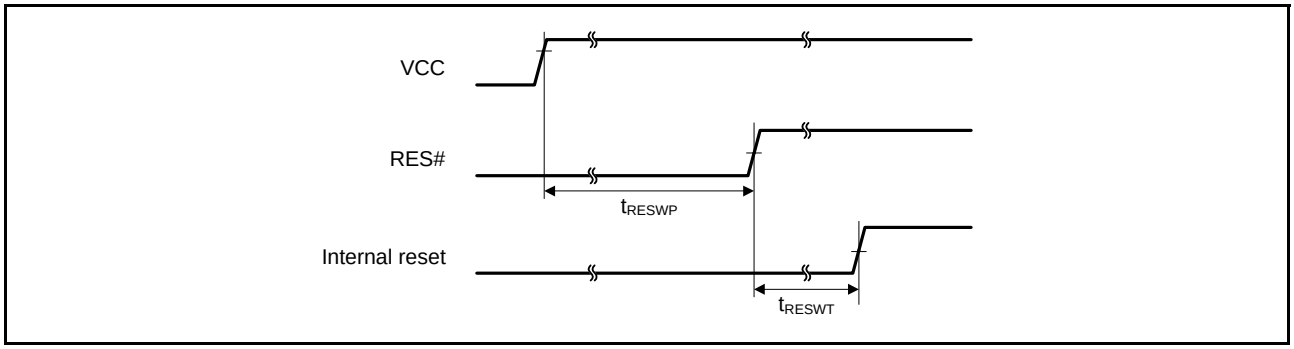


Figure 5.25 Reset Input Timing at Power-On

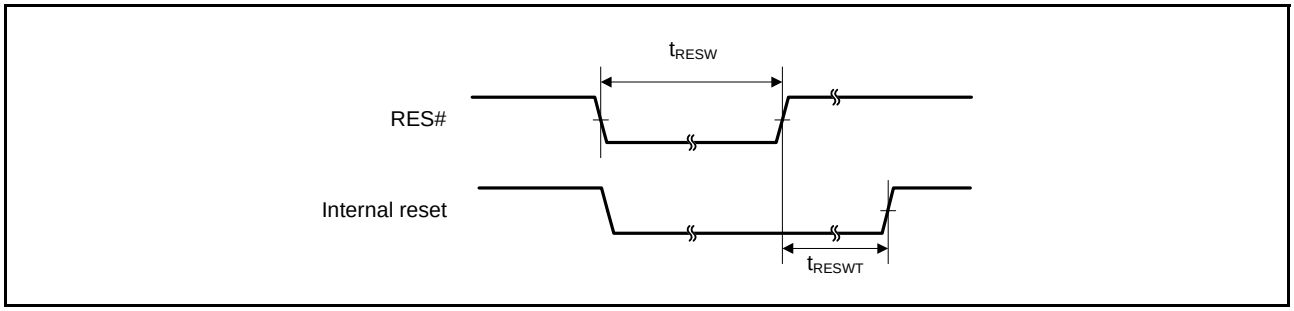


Figure 5.26 Reset Input Timing (1)

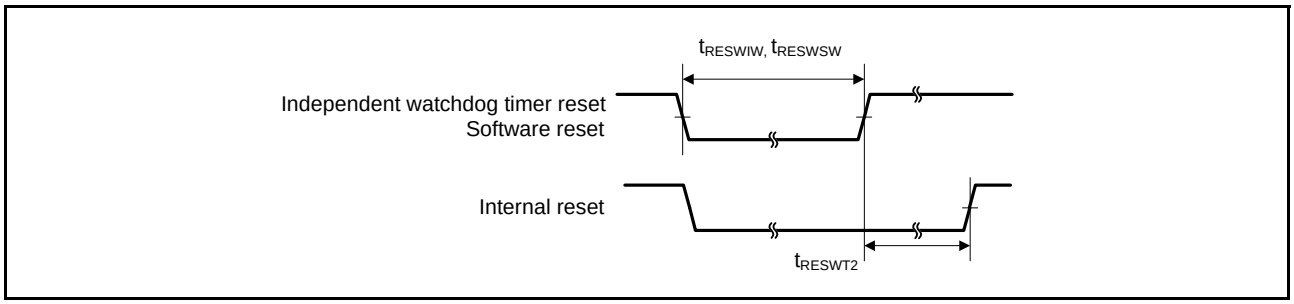


Figure 5.27 Reset Input Timing (2)

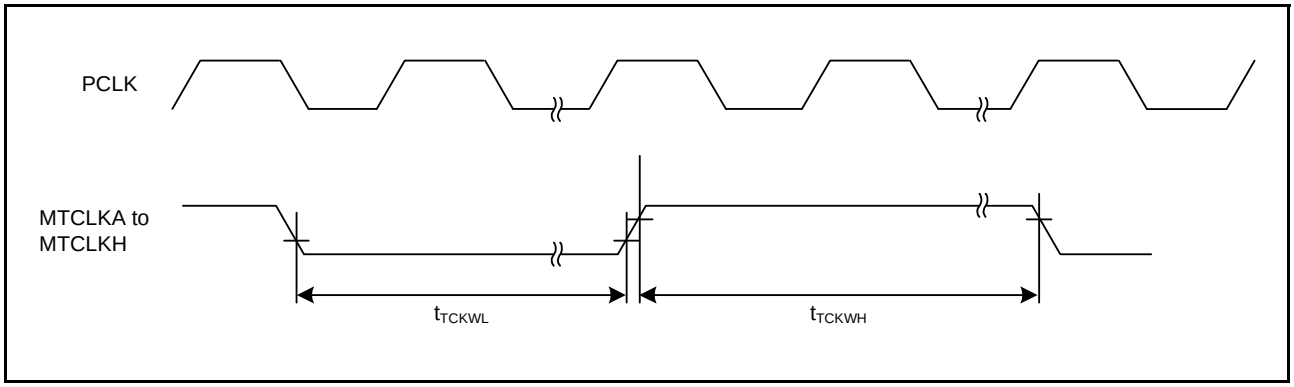


Figure 5.34 MTU2 Clock Input Timing

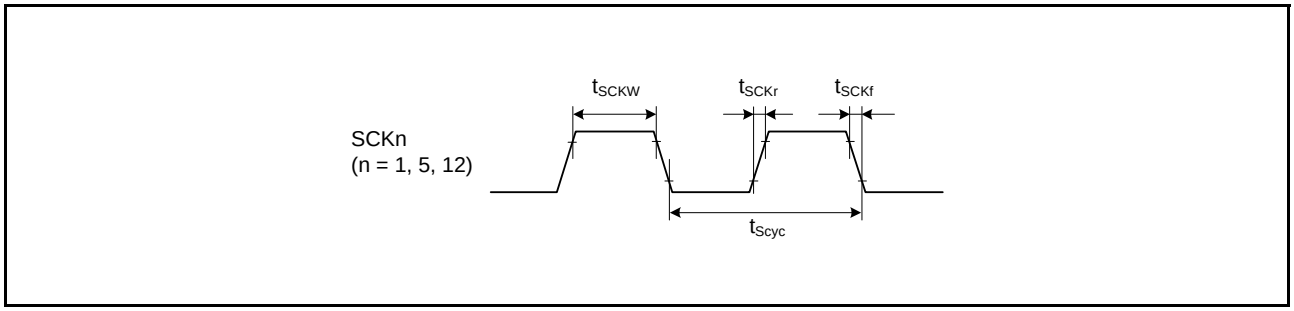


Figure 5.35 SCK Clock Input Timing

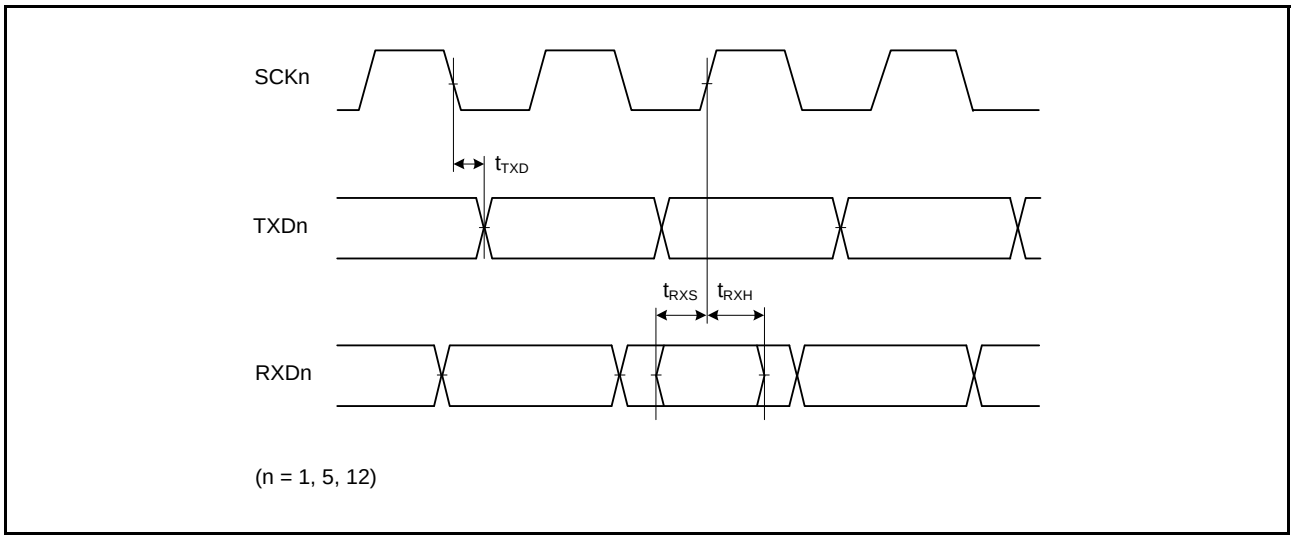


Figure 5.36 SCI Input/Output Timing: Clock Synchronous Mode

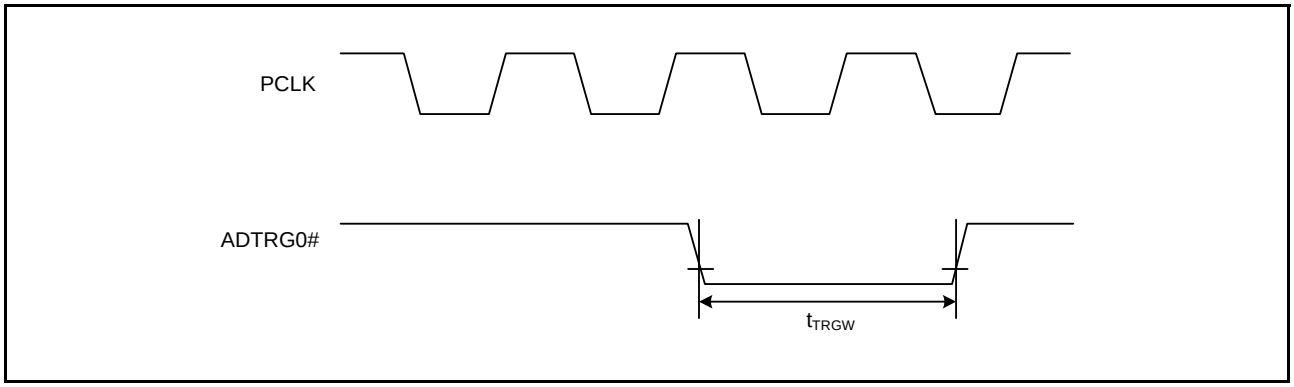


Figure 5.37 A/D Converter External Trigger Input Timing

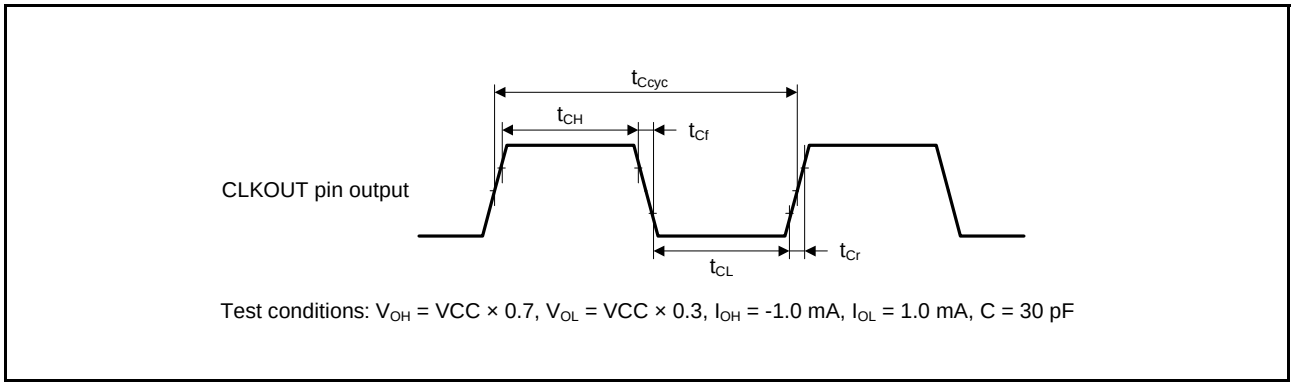


Figure 5.38 CLKOUT Output Timing

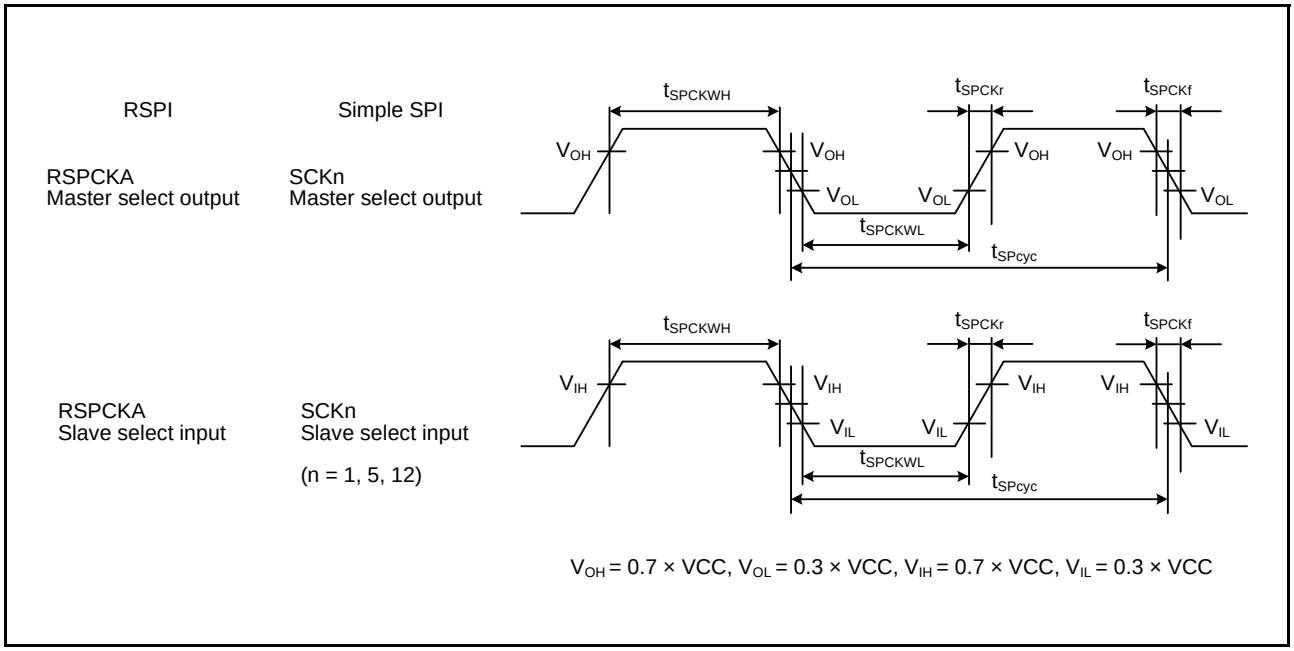


Figure 5.39 RSPI Clock Timing and Simple SPI Clock Timing

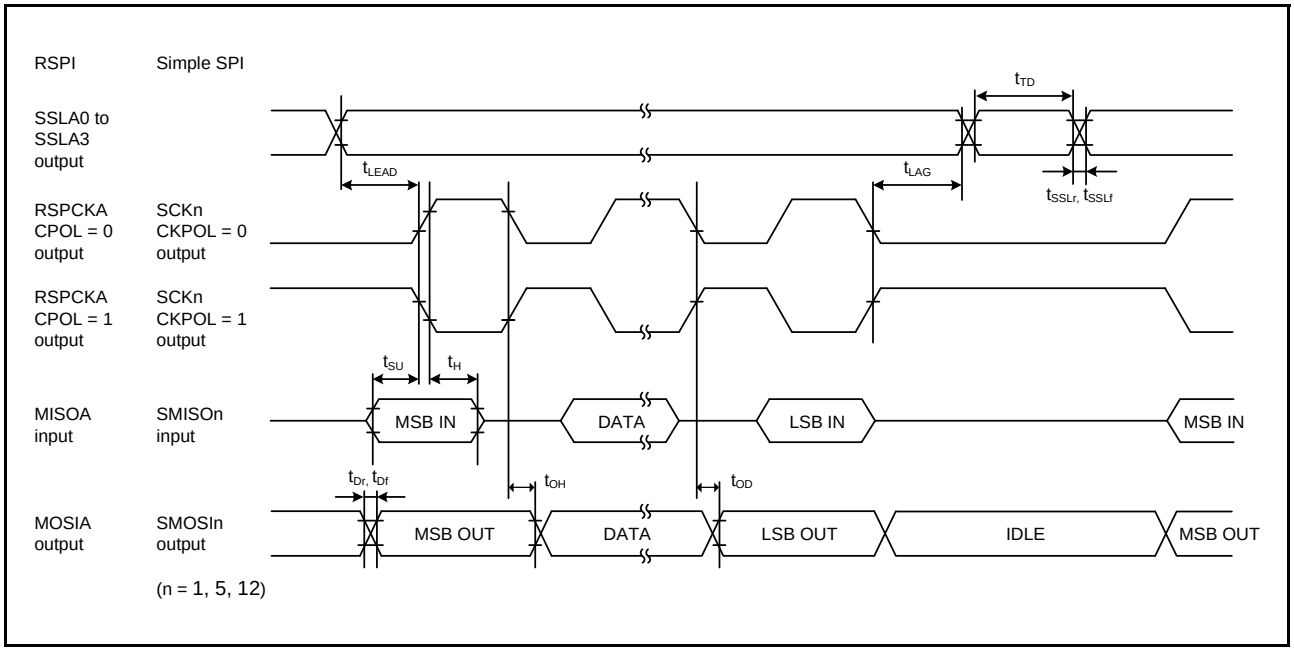


Figure 5.40 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKB Set to Division Ratio Other Than Divided by 2) and Simple SPI Timing (Master, CKPH = 1)

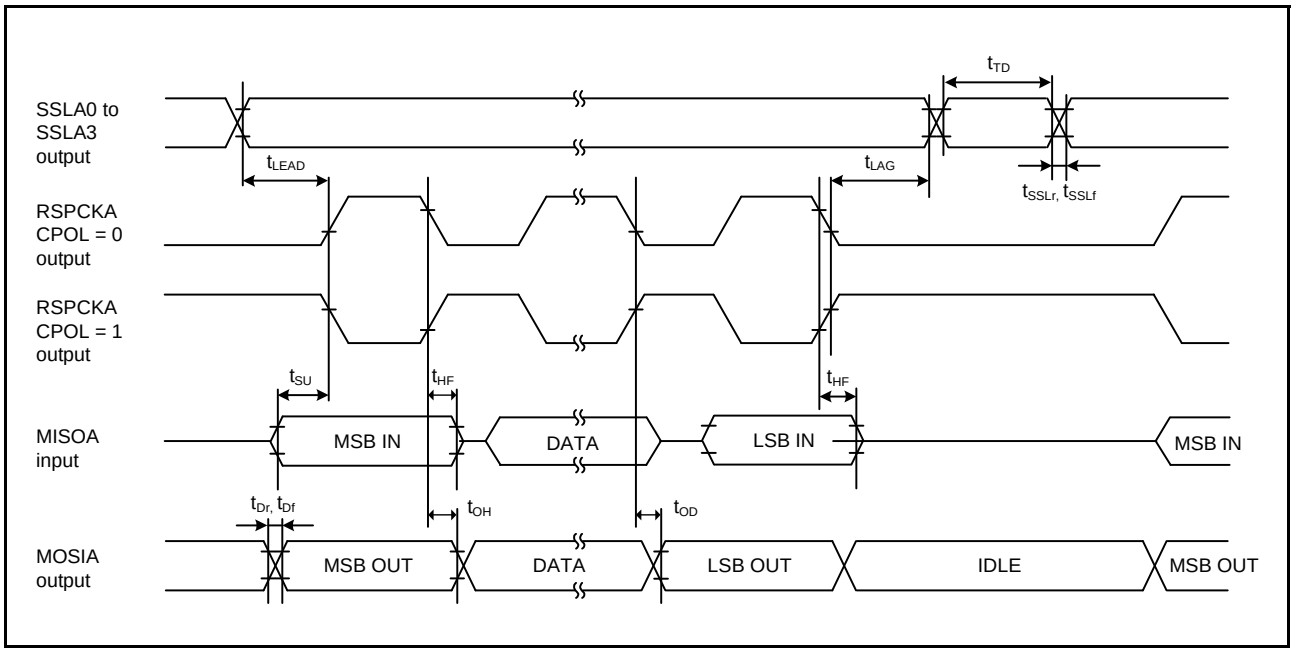


Figure 5.41 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKB Set to Divided by 2)

5.4 A/D Conversion Characteristics

Table 5.35 A/D Conversion Characteristics (1)

Conditions: 2.7 V ≤ VCC ≤ 3.6 V, 2.7 V ≤ AVCC0 ≤ 3.6 V, 2.7 V ≤ VREFH0 ≤ AVCC0, VSS = AVSS0 = VREFL0 = 0 V,
T_a = –40 to +105°C

Item		Min.	Typ.	Max.	Unit	Test Conditions
Frequency		4	—	32	MHz	
Resolution		—	—	12	Bit	
Conversion time*1 (Operation at PCLKD = 32 MHz)	Permissible signal source impedance (Max.) = 0.3 kΩ	1.031 (0.313)*2	—	—	µs	High-precision channel ADCSR.ADHSC bit = 1 ADSSTRn.SST[7:0] bits = 09h
		1.375 (0.641)*2	—	—		Normal-precision channel ADCSR.ADHSC bit = 1 ADSSTRn.SST[7:0] bits = 14h
Analog input effective range		0	—	VREFH0	V	
Offset error		—	±0.5	±4.5	LSB	High-precision channel PJ6PFS.ASEL bit = 1 PJ7PFS.ASEL bit = 1
				±6.0	LSB	Other than above
Full-scale error		—	±0.75	±4.5	LSB	High-precision channel PJ6PFS.ASEL bit = 1 PJ7PFS.ASEL bit = 1
				±6.0	LSB	Other than above
Quantization error		—	±0.5	—	LSB	
Absolute accuracy		—	±1.25	±5.0	LSB	High-precision channel PJ6PFS.ASEL bit = 1 PJ7PFS.ASEL bit = 1
				±8.0	LSB	Other than above
DNL differential nonlinearity error		—	±1.0	—	LSB	
INL integral nonlinearity error		—	±1.0	±3.0	LSB	

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.

Note 1. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 2. The value in parentheses indicates the sampling time.

5.6 Power-On Reset Circuit and Voltage Detection Circuit Characteristics

Table 5.41 Power-On Reset Circuit and Voltage Detection Circuit Characteristics (1)

Conditions: 1.8 V ≤ VCC ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage detection level	Power-on reset (POR)	V_{POR}	1.35	1.50	1.65	V	Figure 5.49, Figure 5.50
	Voltage detection circuit (LVD1)*1	V_{det1_4}	3.00	3.10	3.20	V	Figure 5.51 At falling edge VCC
		V_{det1_5}	2.91	3.00	3.09		
		V_{det1_6}	2.81	2.90	2.99		
		V_{det1_7}	2.70	2.79	2.88		
		V_{det1_8}	2.60	2.68	2.76		
		V_{det1_9}	2.50	2.58	2.66		
		V_{det1_A}	2.40	2.48	2.56		
		V_{det1_B}	1.99	2.06	2.13		
		V_{det1_C}	1.90	1.96	2.02		
		V_{det1_D}	1.80	1.86	1.92		

Note: These characteristics apply when noise is not superimposed on the power supply. When a setting is made so that the voltage detection level overlaps with that of the voltage detection circuit (LVD2), it cannot be specified which of LVD1 and LVD2 is used for voltage detection.

Note 1. n in the symbol Vdet1_n denotes the value of the LVDLVLR.LVD1LVL[3:0] bits.

Table 5.42 Power-On Reset Circuit and Voltage Detection Circuit Characteristics (2)

Conditions: 1.8 V ≤ VCC ≤ 3.6 V, 1.8 V ≤ AVCC0 ≤ 3.6 V, VSS = AVSS0 = 0 V, T_a = –40 to +105°C

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Voltage detection level	Voltage detection circuit (LVD2)*1	V_{det2_0}	2.71	2.90	3.09	V	Figure 5.52 At falling edge VCC
		V_{det2_1}	2.43	2.60	2.77		
		V_{det2_2}	1.87	2.00	2.13		
		V_{det2_3}*2	1.69	1.80	1.91		
Wait time after power-on reset cancellation	At normal startup*3	t_{POR}	—	9.1	—	ms	Figure 5.50
	During fast startup time*4	t_{POR}	—	1.6	—		
Wait time after voltage monitoring 1 reset cancellation	Power-on voltage monitoring 1 reset disabled*3	t_{LVD1}	—	568	—	µs	Figure 5.51
	Power-on voltage monitoring 1 reset enabled*4		—	100	—		
Wait time after voltage monitoring 2 reset cancellation		t_{LVD2}	—	100	—	µs	Figure 5.52
Response delay time		t_{det}	—	—	350	µs	Figure 5.49
Minimum VCC down time*5		t_{VOFF}	350	—	—	µs	Figure 5.49, VCC = 1.0 V or above
Power-on reset enable time		$t_{W(POR)}$	1	—	—	ms	Figure 5.50, VCC = below 1.0 V
LVD operation stabilization time (after LVD is enabled)		$Td_{(E-A)}$	—	—	300	µs	Figure 5.51, Figure 5.52
Hysteresis width (LVD1 and LVD2)		V_{LVH}	—	70	—	mV	Vdet1_4 selected
			—	60	—		Vdet1_5 to 9, LVD2 selected
			—	50	—		When selection is from among Vdet1_A to B.
			—	40	—		When selection is from among Vdet1_C to D.

Note: These characteristics apply when noise is not superimposed on the power supply. When a setting is made so that the voltage detection level overlaps with that of the voltage detection circuit (LVD1), it cannot be specified which of LVD1 and LVD2 is used for voltage detection.

Note 1. n in the symbol Vdet2_n denotes the value of the LVDLVLR.LVD2LVL[3:0] bits.

Note 2. Vdet2_3 selection can be used only when the CMPA2 pin input voltage is selected and cannot be used when the power supply voltage (VCC) is selected.

Note 3. When OFS1.(STUPLVD1REN, FASTSTUP) = 11b.

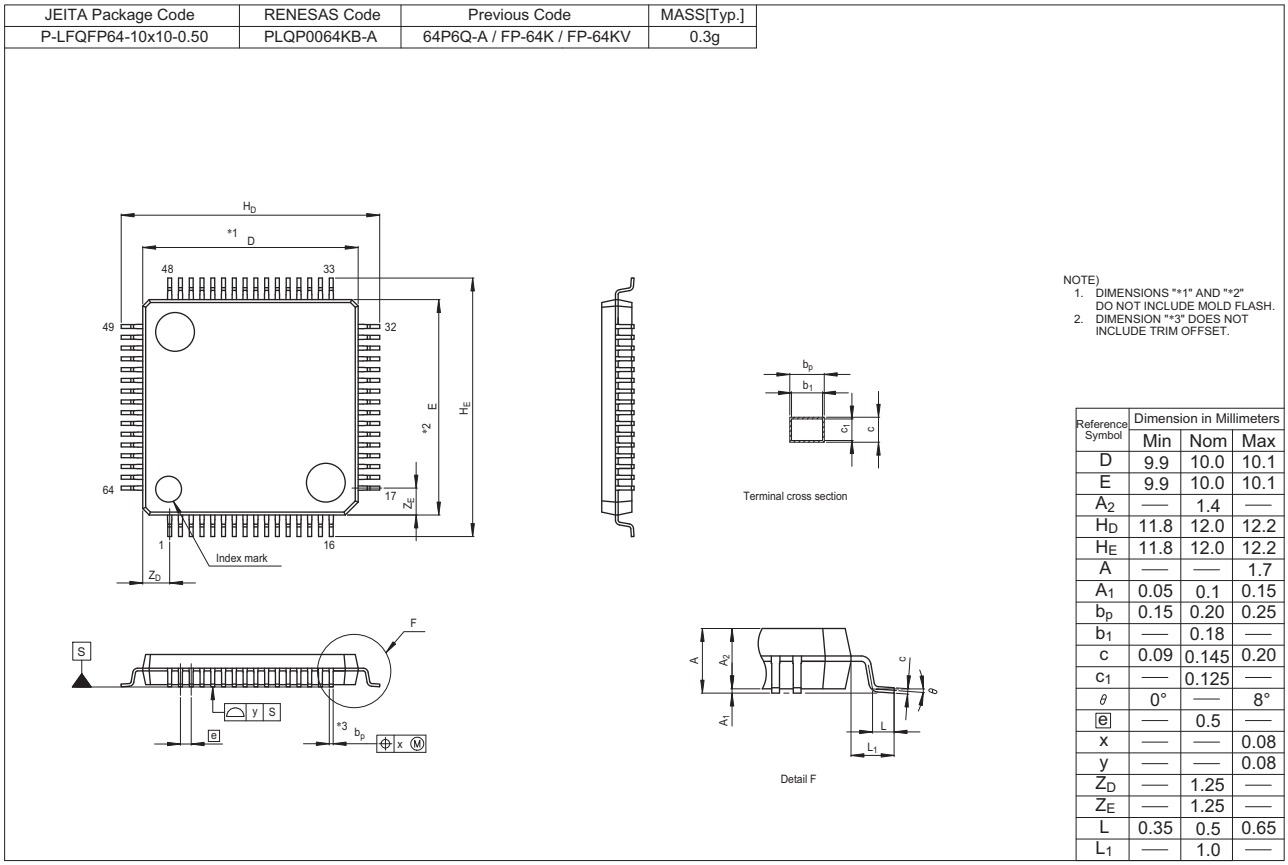
Note 4. When OFS1.(STUPLVD1REN, FASTSTUP) ≠ 11b.

Note 5. The minimum VCC down time indicates the time when VCC is below the minimum value of voltage detection levels V_{POR}, V_{det0}, V_{det1}, and V_{det2} for the POR/LVD.

Appendix 1. Package Dimensions

Information on the latest version of the package dimensions or mountings has been displayed in “Packages” on Renesas Electronics Corporation website.

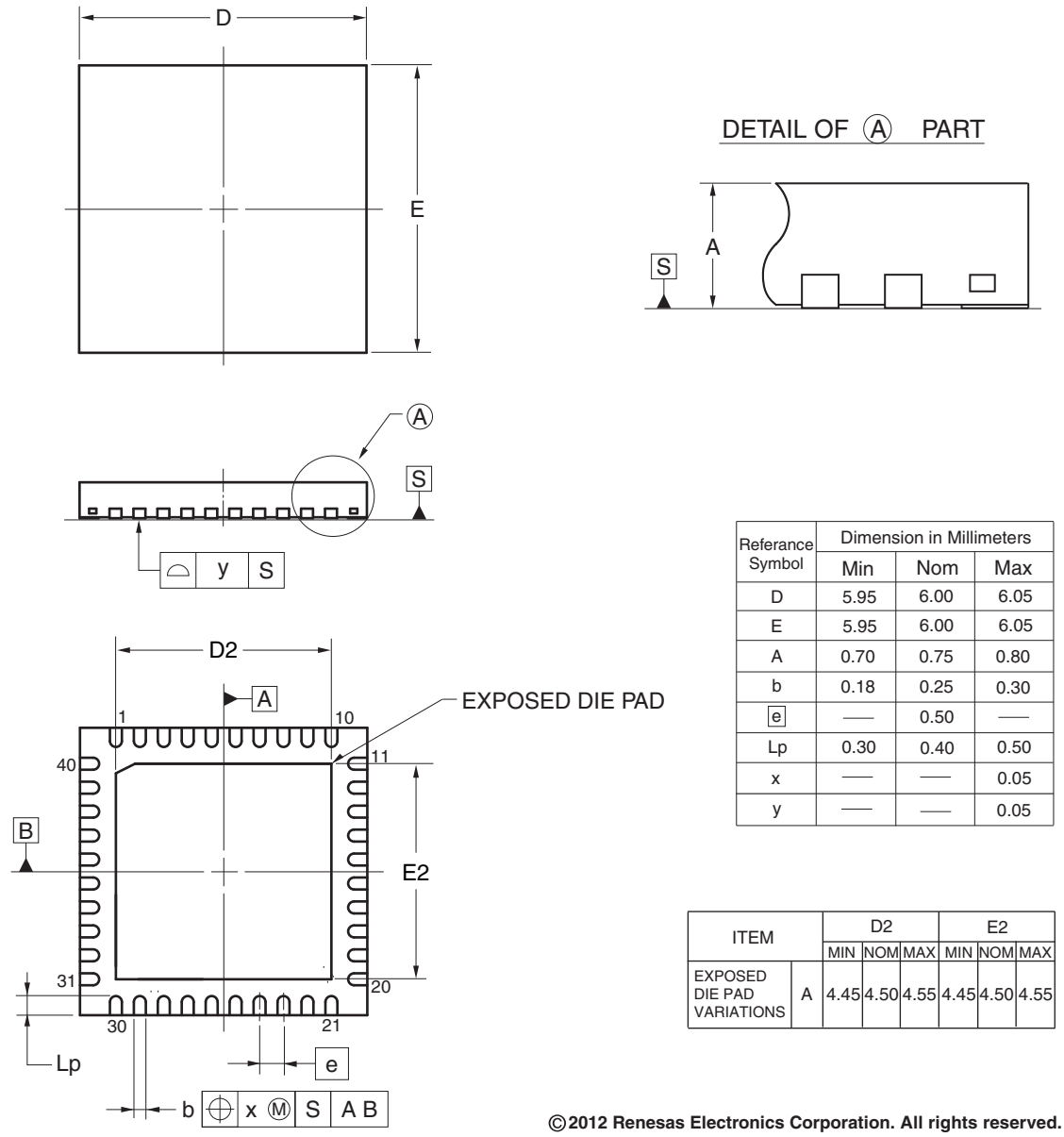
JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LFQFP64-10x10-0.50	PLQP0064KB-A	64P6Q-A / FP-64K / FP-64KV	0.3g



Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	9.9	10.0	10.1
E	9.9	10.0	10.1
A_2	—	1.4	—
H_D	11.8	12.0	12.2
H_E	11.8	12.0	12.2
A	—	—	1.7
A_1	0.05	0.1	0.15
b_p	0.15	0.20	0.25
b_1	—	0.18	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.5	—
x	—	—	0.08
y	—	—	0.08
Z_D	—	1.25	—
Z_E	—	1.25	—
L	0.35	0.5	0.65
L_1	—	1.0	—

Figure A 64-Pin LFQFP (PLQP0064KB-A)

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-HWQFN40-6x6-0.50	PWQN0040KC-A	P40K8-50-4B4-4	0.09



Referance Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	5.95	6.00	6.05
E	5.95	6.00	6.05
A	0.70	0.75	0.80
b	0.18	0.25	0.30
e	—	0.50	—
Lp	0.30	0.40	0.50
x	—	—	0.05
y	—	—	0.05

ITEM		D2			E2		
		MIN	NOM	MAX	MIN	NOM	MAX
EXPOSED DIE PAD VARIATIONS	A	4.45	4.50	4.55	4.45	4.50	4.55

Figure F 40-Pin HWQFN (PWQN0040KC-A)

NOTES FOR CMOS DEVICES

(1) VOLTAGE APPLICATION WAVEFORM AT INPUT PIN: Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between VIL (MAX) and VIH (MIN) due to noise, etc., the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between VIL (MAX) and VIH (MIN).

(2) HANDLING OF UNUSED INPUT PINS: Unconnected CMOS device inputs can be cause of malfunction. If an input pin is unconnected, it is possible that an internal input level may be generated due to noise, etc., causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using pull-up or pull-down circuitry. Each unused pin should be connected to VDD or GND via a resistor if there is a possibility that it will be an output pin. All handling related to unused pins must be judged separately for each device and according to related specifications governing the device.

(3) PRECAUTION AGAINST ESD: A strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it when it has occurred. Environmental control must be adequate. When it is dry, a humidifier should be used. It is recommended to avoid using insulators that easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors should be grounded. The operator should be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with mounted semiconductor devices.

(4) STATUS BEFORE INITIALIZATION: Power-on does not necessarily define the initial status of a MOS device. Immediately after the power source is turned ON, devices with reset functions have not yet been initialized. Hence, power-on does not guarantee output pin levels, I/O settings or contents of registers. A device is not initialized until the reset signal is received. A reset operation must be executed immediately after power-on for devices with reset functions.

(5) POWER ON/OFF SEQUENCE: In the case of a device that uses different power supplies for the internal operation and external interface, as a rule, switch on the external power supply after switching on the internal power supply. When switching the power supply off, as a rule, switch off the external power supply and then the internal power supply. Use of the reverse power on/off sequences may result in the application of an overvoltage to the internal elements of the device, causing malfunction and degradation of internal elements due to the passage of an abnormal current. The correct power on/off sequence must be judged separately for each device and according to related specifications governing the device.

(6) INPUT OF SIGNAL DURING POWER OFF STATE : Do not input signals or an I/O pull-up power supply while the device is not powered. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Input of signals during the power off state must be judged separately for each device and according to related specifications governing the device.

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